

February 1990 Revised November 1999

100311

Low Skew 1:9 Differential Clock Driver

General Description

The 100311 contains nine low skew differential drivers, designed for generation of multiple, minimum skew differential clocks from a single differential input (CLKIN, $\overline{\text{CLKIN}}$). If a single-ended input is desired, the V_{BB} output pin may be used to drive the remaining input line. A HIGH on the enable pin ($\overline{\text{EN}}$) will force a $\underline{\text{LOW}}$ on all of the $\overline{\text{CLK}}_n$ outputs and a HIGH on all of the $\overline{\text{CLK}}_n$ output pins. The 100311 is ideal for distributing a signal throughout a system without worrying about the original signal becoming too corrupted by undesirable delays and skew.

Features

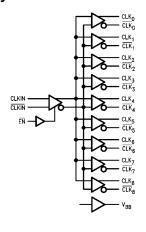
- Low output-to-output skew
- 2000V ESD protection
- 1:9 low skew clock driver
- Differential inputs and outputs
- Available to industrial grade temperature range (PLCC package only)

Ordering Code:

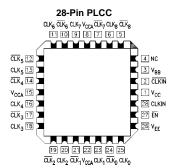
Order Number	Package Number	Package Description
100311QC	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
100311QI		28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (-40°C to +85°C)

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description
CLKIN, CLKIN	Differential Clock Inputs
EN	Enable
$CLK_{0-8}, \overline{CLK}_{0-8}$	Differential Clock Outputs
V _{BB}	V _{BB} Output
NC	No Connect

Truth Table

CLKIN	CLKIN	EN	CLK _n	CLK _n
L	Н	L	L	Н
Н	L	L	Н	L
Х	Х	Н	L	Н

Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

Case Temperature (T_C)

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

DC Electrical Characteristics (Note 3)

 $V_{EE} = -4.2 V$ to $-5.7 V,~V_{CC} = V_{CCA} = GND,~T_{C} = 0 ^{\circ} C$ to $+85 ^{\circ} C$

Symbol	Parameter	Min	Тур	Max	Units	Conditions			
V _{OH}	Output HIGH Voltage	-1025	-955	-870	mV	V _{IN} = V _{IH} (Max)	Loading with		
V _{OL}	Output LOW Voltage	-1830	-1705	-1620	mV	or V _{IL} (Min)	50Ω to -2.0V		
V _{OHC}	Output HIGH Voltage	-1035			mV	$V_{IN} = V_{IH}$	Loading with		
V _{OLC}	Output LOW Voltage			-1610	mV	or V _{IL} (Max)	50Ω to -2.0V		
V_{BB}	Output Reference Voltage	-1380	-1320	-1260	mV	$I_{VBB} = -300 \mu A$			
V _{DIFF}	Input Voltage Differential	150			mV	Required for Full Output Swing			
V _{CM}	Common Mode Voltage	V _{CC} - 2.0		V _{CC} - 0.5	V				
V _{IH}	Input HIGH Voltage	-1165		-870	mV	Guaranteed HIGH Signal for			
						All Inputs			
V _{IL}	Input LOW Voltage	-1830		-1475	mV	Guaranteed LOW Signal for			
						All Inputs			
I _{IL}	Input LOW Current	0.50			μΑ	$V_{IN} = V_{IL}$ (Min)			
I _{IH}	Input HIGH Current					V _{IN} = V _{IH} (Max)			
	CLKIN, CLKIN			100	μΑ				
	EN			250					
I _{CBO}	Input Leakage Current	-10			μΑ	$V_{IN} = V_{EE}$			
I _{EE}	Power Supply Current	-115		-57	mA	Inputs Open			

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Commercial Version (Continued) AC Electrical Characteristics

 $V_{\text{EE}} = -4.2 \text{V to } -5.7 \text{V}, \ V_{\text{CC}} = V_{\text{CCA}} = \text{GND}$

Parameter		$T_C = 0^{\circ}C$;	T	T _C = +25°C			_C = +85°	С	Unite	Conditions
	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Ullits	Conditions
Max Toggle Frequency	750			750			750			MHz	(Note 4)
CLKIN to Q _n											
Propagation Delay,											
CLKIN _n to CLK _n											
Differential	0.75	0.84	0.95	0.75	0.86	0.95	0.84	0.93	1.04	ns	Figure 3
Single-Ended	0.65	0.90	1.05	0.67	0.93	1.17	0.74	1.06	1.24		
Propagation Delay	0.75	1.03	1.20	0.80	1.05	1.25	0.85	1.12	1.35	ns	Figure 2
SEL to Output											
LH-HL Skew		10	30		10	30		10	30		(Note 5)(Note 8)
Gate-Gate Skew LH		20	50		20	50		20	50	no	(Note 6)(Note 8)
Gate-Gate Skew HL		20	50		20	50		20	50	ps	(Note 6)(Note 8)
Gate-Gate LH-HL Skew		30	60		30	60		30	60		(Note 7)(Note 8)
Setup Time	250			250			300			ps	
EN _n to CLKIN _n											
Hold Time	0			0			0			ps	
EN _n to CLKIN _n											
Release Time	300			300			300			ps	
EN _n to CLKIN _n											
Transition Time	275	500	750	275	480	750	275	460	750	ps	Figure 4
20% to 80%, 80% to 20%											
	Max Toggle Frequency CLKIN to Q _n Propagation Delay, CLKIN _n to CLK _n Differential Single-Ended Propagation Delay SEL to Output LH-HL Skew Gate-Gate Skew LH Gate-Gate Skew HL Gate-Gate LH-HL Skew Setup Time EN _n to CLKIN _n Hold Time EN _n to CLKIN _n Release Time EN _n to CLKIN _n	Nameter Min	Max Toggle Frequency	Min Typ Max	Parameter Min Typ Max Min 750 750 750 750 750 750 750 750 750 750 750 750 CLKINn Single-Ended 0.65 0.90 1.05 0.67 Propagation Delay SEL to Output 0.75 1.03 1.20 0.80 BEL to Output 10 30 30 60 Gate-Gate Skew LH Gate-Gate LH-HL Skew 20 50 50 30 60 Setup Time ENn to CLKINn 250 250 250 250 250 ENn to CLKINn 0 0 0 0 0 0 Release Time ENn to CLKINn 300 300 300 300 275	Min Typ Max Min Typ Max Typ Typ Max Typ Typ Max Typ Typ	Min Typ Max Min Typ Max	Min Typ Max Min Typ Max Min Min	Min Typ Max Min Typ Typ	Min Typ Max Typ Typ	Min Typ Max Typ Typ

Note 4: f_{MAX} = the highest frequency at which output V_{QL}/V_{QH} levels still meet V_{IN} specifications. The F311 will function @ 1 GHz.

Note 5: tpS describes opposite edge skews, i.e. the difference between the delay of a differential output signal pair's LOW-to-HIGH and HIGH-to-LOW propagation delays. With differential signal pairs, a LOW-to-HIGH or HIGH-to-LOW transition is defined as the transition of the true output or input pin.

Note 6: t_{OSLH} describes in-phase gate-to-gate differential propagation skews with all differential outputs going LOW-to-HIGH; t_{OSHL} describes the same conditions except with the outputs going HIGH-to-LOW.

Note 7: t_{OST} describes the maximum worst case difference in any of the t_{PS} , t_{OSLH} or t_{OST} delay paths combined.

Note 8: The skew specifications pertain to differential I/O paths.

Industrial Version

DC Electrical Characteristics (Note 9)

 $V_{EE} = -4.2 V$ to $-5.7 V,~V_{CC} = V_{CCA} = GND,~T_{C} = -40 ^{\circ}C$ to $+85 ^{\circ}C$

Symbol	Parameter	T _C = -	–40°C	T _C = 0°C	to +85°C	Units	Conditions		
Cy.11001		Min	Max	Min	Max	Onito			
V _{OH}	Output HIGH Voltage	-1085	-870	-1025	-870	mV	V _{IN} = V _{IH} (Max)	Loading with	
V _{OL}	Output LOW Voltage	-1830	-1575	-1830	-1620	mV	or V _{IL} (Min)	50Ω to -2.0V	
V _{OHC}	Output HIGH Voltage	-1095		-1035		mV	$V_{IN} = V_{IH}$	Loading with	
V _{OLC}	Output LOW Voltage		-1565		-1610	mV	or V _{IL} (Min)	50Ω to $-2.0V$	
V_{BB}	Output Reference Voltage	-1395	-1255	-1380	-1260	mV	$I_{VBB} = -300 \mu A$		
V_{DIFF}	Input Voltage Differential	150		150		mV	Required for Full Out	put Swing	
V_{CM}	Common Mode Voltage	V _{CC} - 2.0	V _{CC} - 0.5	V _{CC} - 2.0	V _{CC} -0.5	V			
V _{IH}	Input HIGH Voltage	-1170	-870	-1165	-870	mV	Guaranteed HIGH Si	gnal for	
							All Inputs		

Industrial Version (Continued) DC Electrical Characteristics (Note 9)

 $V_{EE} = -4.2V$ to -5.7V, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	T _C = -	-40°C	T _C = 0°C	to +85°C	Units	Conditions		
		Min	Max	Min	Max	Onito	Conditions		
V _{IL}	Input LOW Voltage	-1830	-1480	-1830	-1475	mV	Guaranteed LOW Signal for		
							All Inputs		
I _{IL}	Input LOW Current	0.50		0.50		μΑ	V _{IN} = V _{IL} (Min)		
I _{IH}	Input HIGH Current						V _{IN} = V _{IH} (Max)		
	CLKIN, CLKIN		100		100	μΑ			
	EN		250		250				
I _{CBO}	Input Leakage Current	-10		-10		μΑ	$V_{IN} = V_{EE}$		
I _{EE}	Power Supply Current	-115	-57	-115	-57	mA	Inputs Open		
V_{PP}	Minimum Input Swing	150		150		mV			
V _{CMR}	Common Mode Range	V _{CC} -2.0	V _{CC} -0.5	V _{CC} -2.0	V _{CC} -0.5	V			

Note 9: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

AC Electrical Characteristics

 $V_{EE} = -4.2 V$ to -5.7 V, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	Т	C = -40°	C	$T_C = +25^{\circ}C$			T _C = +85°C			Units	Conditions
		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Ullits	Conditions
f _{MAX}	Max Toggle Frequency	750			750			750			MHz	(Note 10)
	CLKIN to Q _n											
t _{PLH}	Propagation Delay,											
t_{PHL}	CLKIN _n to CLK _n											
	Differential	0.72	0.81	0.92	0.77	0.86	0.95	0.84	0.93	1.04	ns	Figure 3
	Single-Ended	0.62	0.89	1.02	0.67	0.93	1.17	0.74	1.06	1.24		
t _{PLH}	Propagation Delay	0.70	0.97	1.20	0.80	1.05	1.25	0.85	1.12	1.35	ns	Figure 2
t _{PHL}	SEL to Output											
t _{PS}	LH-HL Skew		10	30		10	30		10	30		(Note 11)(Note 14)
toslh	Gate-Gate Skew LH		20	50		20	50		20	50	ps	(Note 12)(Note 14)
t _{OSHL}	Gate-Gate Skew HL		20	50		20	50		20	50		(Note 12)(Note 14)
t _{OST}	Gate-Gate LH-HL Skew		30	60		30	60		30	60		(Note 13)(Note 14)
t _S	Setup Time	250			250			300			ps	
	EN _n to CLKIN _n											
t _H	Hold Time	0			0			0			ps	
	EN _n to CLKIN _n											
t _R	Release Time	300			300			300			ps	
	EN _n to CLKIN _n											
t _{TLH}	Transition Time	275	500	750	275	480	750	275	460	750	ps	Figure 4
t_{THL}	20% to 80%, 80% to 20%											

Note 10: f_{MAX} = the highest frequency of which output V_{OL}/V_{OH} levels still meet V_{IN} specifications. The F311 will function @ 1 GHz

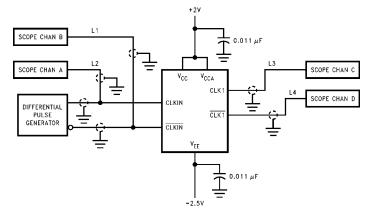
Note 11: t_{PS} describes opposite edge skews, i.e. the difference between the delay of a differential output signal pair's LOW-to-HIGH and HIGH-to-LOW propagation delays. With differential signal pairs, a LOW-to-HIGH or HIGH-to-LOW transition is defined as the transition of the true output or input pin.

Note 12: t_{OSLH} describes in-phase gate differential propagation skews with all differential outputs going LOW-to-HIGH; t_{OSHL} describes the same conditions except with the outputs going HIGH-to-LOW.

Note 13: t_{OST} describes the maximum worst case difference in any of the t_{PS} , t_{OSLH} or t_{OST} delay paths combined.

Note 14: The skew specifications pertain to differential I/O paths.

Test Circuit



Note:

Shown for testing CLKIN to CLK1 in the differential mode.

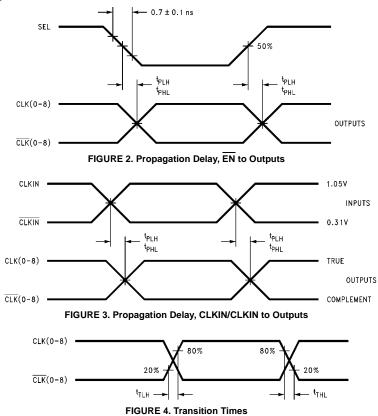
L1, L2, L3 and L4 = equal length 50Ω impedance lines.

All unused inputs and outputs are loaded with 50 $\!\Omega$ in parallel with $\!\leq\!3$ pF to GND.

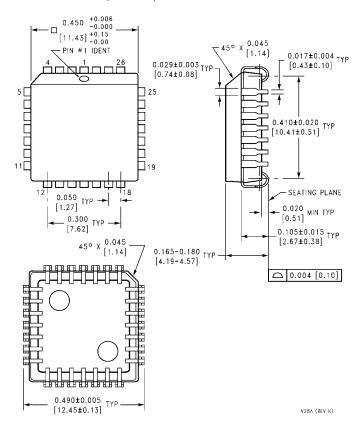
Scope should have 50Ω input terminator internally.

FIGURE 1. AC Test Circuit

Switching Waveforms



Physical Dimensions inches (millimeters) unless otherwise noted



28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Package Number V28A

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